

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT | |
| NATURE OF CONVEYANCE: | ASSIGNMENT | |
| CONVEYING PARTY DATA | | |
| | Name | Execution Date |
| | CHARLES SCHENCK WILEY | 03/08/2016 |
| | ROBERT F. SPEYER | 03/08/2016 |
| RECEIVING PARTY DATA | | |
| Name: | VERCO MATERIALS, LLC | |
| Street Address: | 654 EIGHTH STREET NW | |
| City: | ATLANTA | |
| State/Country: | GEORGIA | |
| Postal Code: | 30318 | |
| PROPERTY NUMBERS Total: 1 | | |
| | Property Type | Number |
| | Application Number: | 13955898 |
| CORRESPONDENCE DATA | | |
| Fax Number: | (212)382-0888 | |
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| Address Line 1: | 1180 AVENUE OF THE AMERICAS | |
| Address Line 4: | NEW YORK, NEW YORK 10036 | |
| ATTORNEY DOCKET NUMBER: | P/4765-26 | |
| NAME OF SUBMITTER: | KOUROSH SALEHI | |
| SIGNATURE: | /KOUROSH SALEHI/ | |
| DATE SIGNED: | 03/14/2016 | |
| | This document serves as an Oath/Declaration (37 CFR 1.63). | |
| Total Attachments: 2 | | |
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| source=01887675#page2.tif | | |

PATENT APPLICATION ASSIGNMENT -
SOLE AND JOINT INVENTORS

OUR FILE NO. P/4765-26

WHEREAS, We, Charles Schenck WILEY and Robert F. SPEYER as assignors, have invented certain improvements in A PROCESS FOR FABRICATION OF HIGH-HARDNESS, FINE-GRAINED, COMPLEX-SHAPED SILICON CARBIDE ARTICLES for which United States Patent Application Serial No. 13/955,898, was filed on July 31, 2013; and

WHEREAS, Verco Materials, LLC, located at 654 Eighth Street NW, Atlanta, GA 30318, as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, We, as assignors, hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, non-provisional, divisional, continuation, substitute, reissue, continuation-in-part, or reexamination applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for ourselves and our legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date:

3/8/14

Charles Schenck Wiley

Charles Schenck WILEY

Date:

Robert F. SPEYER

PATENT APPLICATION ASSIGNMENT -
SOLE AND JOINT INVENTORS

OUR FILE NO. P/4765-26

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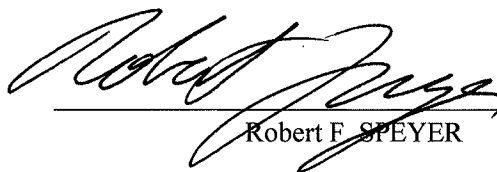
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Date: _____

Charles Schenck WILEY

Date: 3/9/16 _____



Robert F. SPEYER